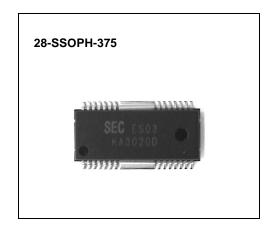
SPINDLE MOTOR DRIVER

The KA3020D is a monolithic integrated circuit, suitable for a 3-phase spindle motor drive of a CD system.

FEATURES

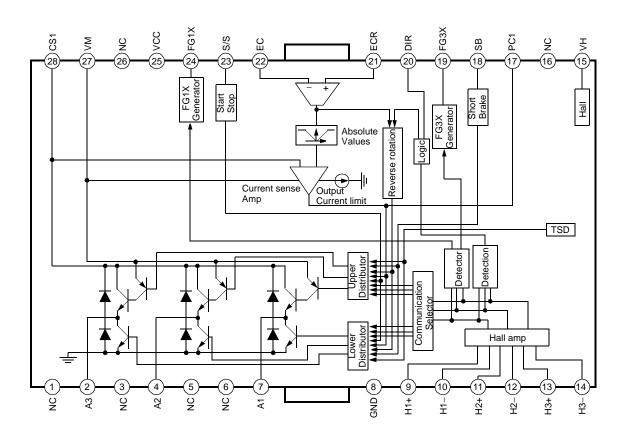
- 3-phase, full-wave, linear BLDC motor driver
- Power save at stop mode
- Built-in current limiter
- Built-in TSD (Thermal shutdown) circuit
- · Built-in 3X or 1X hall FG output
- Built-in hall bias circuit
- Built-in rotational direction detector
- · Built-in reverse rotation preventer
- · Built-in short braker
- Corresponds to 3.3V DSP



ORDERING INFORMATION

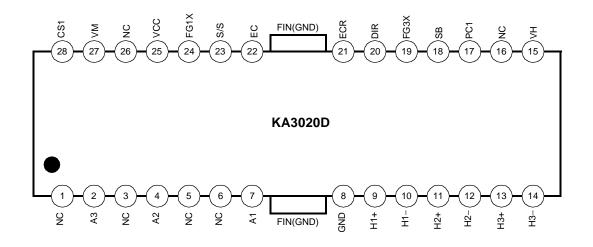
Device	Package	Operating Temperature
KA3020D	28-SSOPH-375	−25°C ~ +75°C

BLOCK DIAGRAM





PIN CONFIGURATION

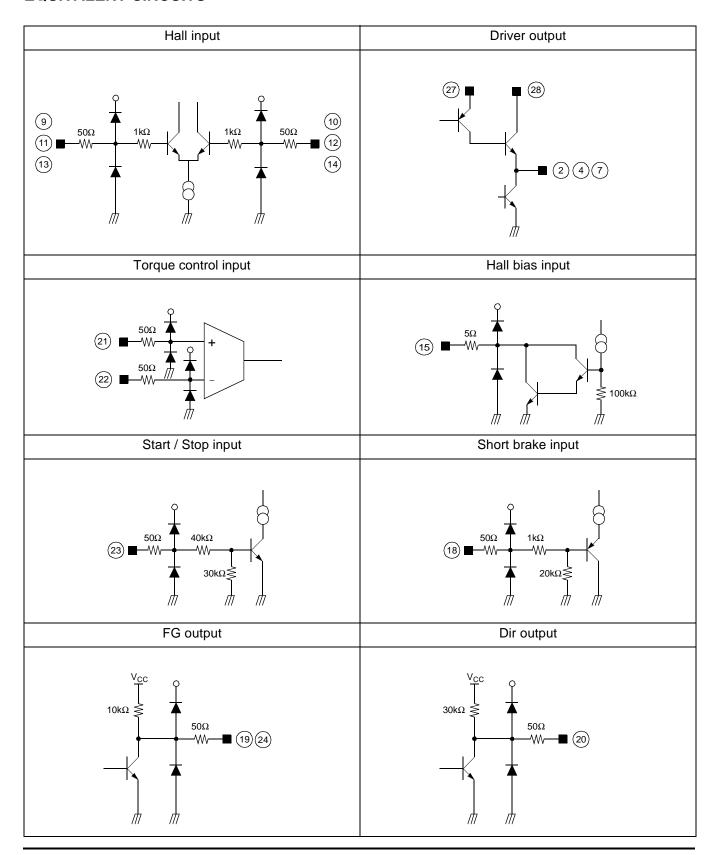


PIN DESCRIPTION

Pin No.	Symbol	I/O	Description	Pin No.	Symbol	I/O	Description
1	NC	_	No connection	15	VH	I	Hall bias
2	А3	0	Output (A3)	16	NC	_	No connection
3	NC	_	No connection	17	PC1	_	Phase compensation capacitor
4	A2	0	Output (A2)	18	SB	I	Short brake
5	NC	_	No connection	19	FG3X	0	FG waveform (3X)
6	NC	_	No connection	20	DIR	0	Rotational direction output
7	A1	0	Output (A1)	21	ECR	I	Output current control reference
8	GND	_	Ground	22	EC	I	Output current control voltage
9	H1+	I	Hall signal (H1+)	23	S/S	I	Power save (Start/Stop switch)
10	H1–	I	Hall signal (H1-)	24	FG1X	0	FG waveform (1X)
11	H2+	I	Hall signal (H2+)	25	VCC	_	Supply voltage (Signal)
12	H2-	I	Hall signal (H2-)	26	NC	_	No connection
13	H3+	I	Hall signal (H3+)	27	VM	_	Supply voltage (Motor)
14	H3–	I	Hall signal (H3-)	28	CS1	_	Output current detection



EQUIVALENT CIRCUITS

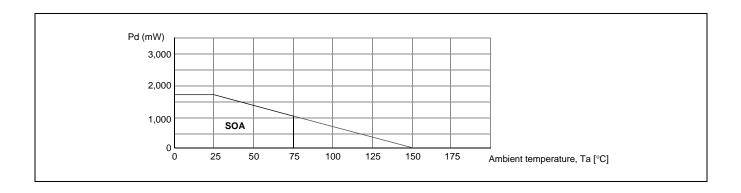


ABSOLUTE MAXIMUM RATINGS (Ta=25°C)

Characteristics	Symbol	Value	Unit
Maximum supply voltage (Signal)	V _{CCMAX}	7	V
Maximum supply voltage (Motor)	V _{MMAX}	15	V
Power dissipation	P _D	@1.7	W
Operating temperature range	T _{OPR}	−25 ~ + 75	°C
Storage temperature range	T _{STG}	−55 ~ + 150	°C

@:

- 1. When mounted on a $50\text{mm} \times 50\text{mm} \times 1\text{mm}$ PCB (Phenolic resin material).
- 2. Power dissipation reduces 13.6mW / $^{\circ}$ C for using above Ta = 25 $^{\circ}$ C
- 3. Do not exceed Pd and SOA (Safe operating area).



RECOMMENDED OPERATING CONDITIONS

Characteristics	Symbol	Min.	Тур.	Max.	Unit
Supply voltage	V _{CC}	4.5	5	5.5	V
Motor supply voltage	V _M	3.0	12	14	V



ELECTRICAL CHARACTERISTICS

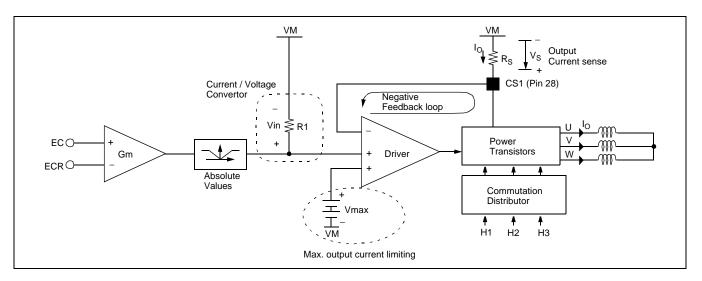
(Unless otherwise specified, Ta=25 $^{\circ}$ C, V_{CC}=5V, V_M=12V)

Characteristics	Characteristics Symbol Test conditions		Min.	Тур.	Max.	Unit
Quiescent circuit current 1	I _{CC1}	At stop mode	-	-	0.2	mA
Quiescent circuit current 2	I _{CC2}	At start mode	-	5	10	mA
START / STOP						
On voltage range	V _{SSON}	Output driver on	2.5	_	V _{CC}	V
Off voltage range	V _{SSOFF}	Output driver off	0.0	_	1.0	V
HALL BIAS				I	I	I
Hall bias voltage	V _{HB}	I _{HB} =20mA	0.4	1.0	1.8	V
HALL AMP						
Hall bias current	I _{HA}	_	_	0.5	2	μΑ
Common-mode input range	V _{HAR}	_	1.5	_	4.0	V
Minimum input level	V _{INH}	_	60	_	_	mVpp
H1 hysteresis level	V _{HYS}	_	5	20	40	mVpp
TORQUE CONTROL				I	I	I
Ecr Input voltage range	E _{CR}	_	0.2	_	3.3	V
Ec Input voltage range	E _C	_	0.2	_	3.3	V
Offset voltage (-)	E _{COFF}	E _C =1.9V	-80	-50	-20	mV
Offset voltage (+)	E _{COFF+}	E _C =1.9V	20	50	80	mV
Ec Input current	E _{CIN}	E _C =1.9V	_	0.3	3	μΑ
Ecr Input current	E _{CRIN}	E _{CR} =1.9V	_	0.3	3	μΑ
Input / output gain	G _{EC}	E_{C} =1.9V, R_{CS} =0.5 Ω	-	0.71	-	A/V
FG				I	I	I
FG output voltage (H)	V _{FGH}	lfg=-10μA	4.5	4.9	_	V
FG output voltage (L)	V _{FGL}	lfg=10μA	_	_	0.5	V
Duty (reference value)		_	_	50	_	%
OUTPUT BLOCK						
Saturation voltage (upper TR)	V _{OH}	I _O =-300mA	_	0.9	1.4	V
Saturation voltage (lower TR)	V _{OL}	I _O =300mA	_	0.4	0.7	V
Torque limit current	I _{TL}	R_{CS} =0.5 Ω	560	700	840	mA
DIRECTION DETECTOR		1		1	1	1
Dir output voltage (H)	V _{DIRH}	lfg=-10μA	4.5	4.7	_	V
Dir output voltage (L)	V _{DIRL}	lfg=10μA	_	_	0.5	V
SHORT BRAKE	1		1	1	1	1



Characteristics	Symbol	Test conditions	Min.	Тур.	Max.	Unit
On voltage range	V _{SBON}	_	2.5	_	V _{CC}	V
Off voltage range	V _{SBOFF}	_	0	_	1.0	V

CALCUALTION OF GAIN & TORQUE LIMIT CURRENT



0.255 which is made from GM times R1 is fixed value within IC.

$$Gain = \frac{0.255}{R_S} [A/V]$$

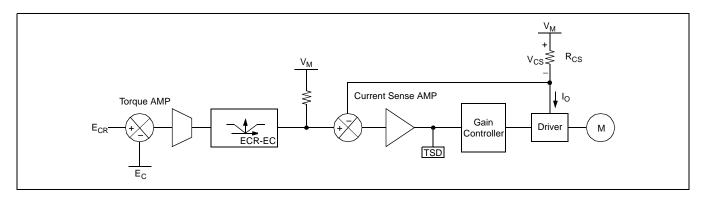
Vmax (see above block diagram) is setted to 350mV.

$$Itl = \frac{Vmax}{R_S} = \frac{350[mV]}{R_S}$$

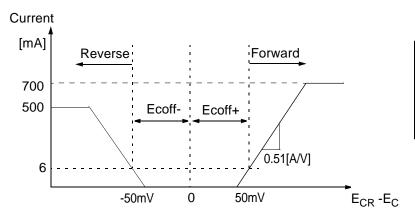


APPLICATION INFORMATION

1. TORQUE CONTROL & OUTPUT CURRENT CONTROL



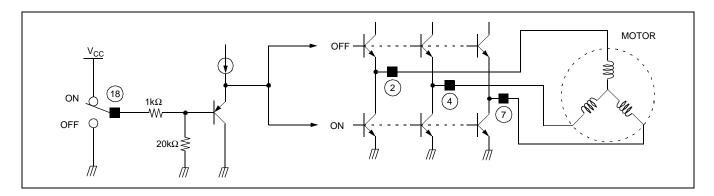
- By amplifying the voltage difference between E_C and ecr from servo IC, the torque sense amp produces the input (V_{AMP}) for the current sense amp.
- The output current (I_O) is converted into the voltage (V_{CS}) through the sense resistor (R_{CS}) and compared with
 the V_{AMP}. By the negative feedback loop, the sensed output voltage, V_{CS} is equal to the input V_{AMP}. Therefore,
 the output current (I_O) is linearly controlled by the input V_{AMP}.
- As a result, the signals, E_C and E_{CR} can control the velocity of the Motor by controlling the output current (I_O) of the driver.
- The range of the torque voltage is as shown below.



	Rotation
E _{CR} > Ec	Forward rotation
E _{CR} < Ec	Stop after detecting reverse rotation

The input range of E_{CR,} E_C is 0.2 V ~ 3.3 V (R_{NF} = 0.5[Ω])

2. SHORT BRAKE



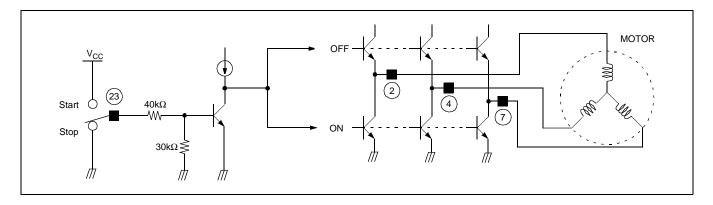
Pin # 18	Short brake
High	On
Low	Off

When the pick-up part moves from the inner to the outer spindle of the CD, the brake function of the reverse voltage is commonly employed to decrease the rotating velocity of the spindle Motor.

However, if the spindle motor rotates rapidly, the brake function of the reverse voltage may produce much heat at the Drive IC.

To remove this shortcoming and to enhance the braking efficiency, the short brake function is added to KA3020D. When the short brake function is active, all upper power TRs turn off and all lower power TRs turn on, so as to make the rotating velocity of the Motor slow down. But FG and DIR functions continue to operate normally.

3. POWER SAVE

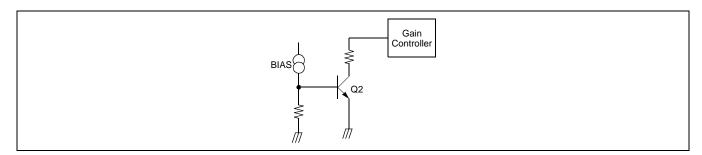


Pin # 23	Start/Stop
High	Operate
Low	Stop

When power save function active, all power TRs turn off but FG and DIR functions continue to operate normally.



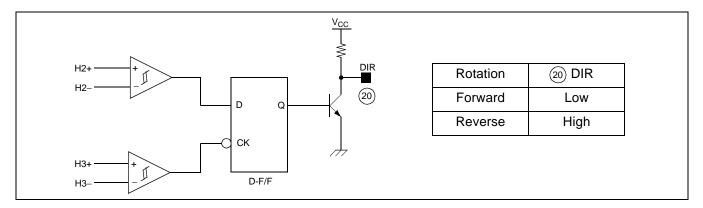
4. TSD (THERMAL SHUTDOWN)



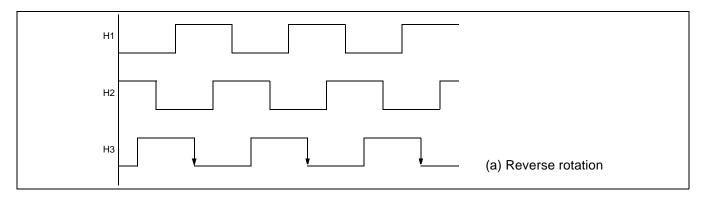
When the chip temperature rises up to about 175°C, the Q2 turns on so that the output driver will be shutdown. When the chip temperature falls off to about 150°C, then the Q2 turns off so that the driver is to operate normally. Thus, TSD has the temperature hysteresis of about 25°C.



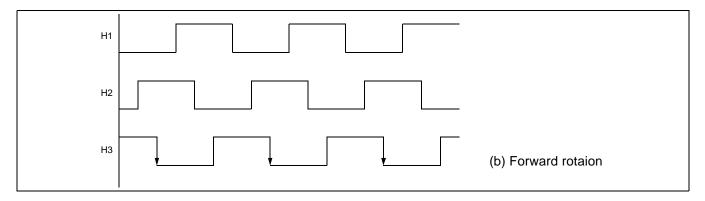
5. ROTATIONAL DIRECTION DETECTION



- The forward and the reverse rotations of the CD are simply detected by using the D-F/F and the truth table is shown in the above table.
- The rotational direction of the CD can be explained by the output waveforms of the Hall sensors. Let the three outputs of Hall sensors be H1, H2 and H3 respectively.
 When the spindle rotates in reverse direction, the Hall sensor output waveforms are shown in Fig.(a). Thus the phases orderd in H1→H2→H3 with a 120°C phase difference.



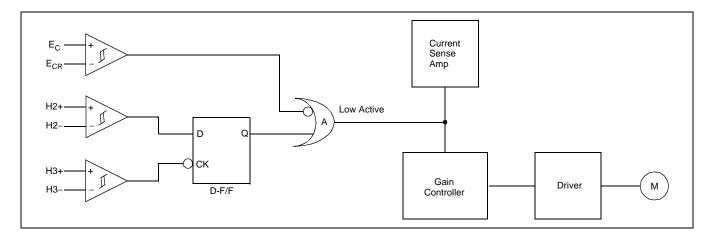
On the other hand, if the spindle rotates in forward rotation, the phase relationship is $H3\rightarrow H2\rightarrow H1$ as shown in fig.(b)



Therefore, the output of the rotational direction detector is low, when the spindle rotates forward, while high as in the case of the reverse rotation.

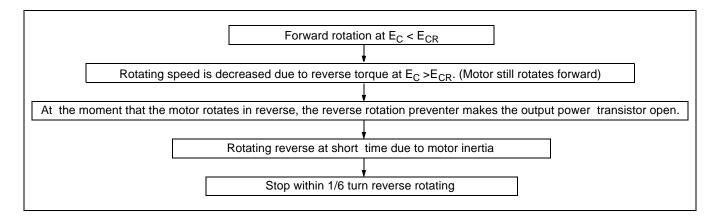


6. REVERSE ROTATION PREVENTION

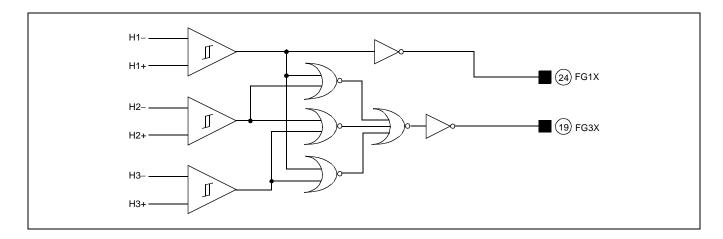


- When the output of the OR gate, A is low, it steers all the output current of the current sense amp makes the
 current delivered to the gain controller zero. Thus the output current of the driver becomes zero and the motor
 is stopped.
- As in the state of the forward rotation, the D-F/F output, Q is high and the motor rotates normally. At this state if the control input is changed such that E_C>E_{CR}, then the motor rotates slowly more and more by the reverse commutation in the driver. At the moment that the motor rotates in reverse direction, the D-F/F output becomes low and the OR gate output, thus, becomes low. This prevents the motor from rotating in reverse direction. The operation principle is shown in the table and the flow chart.

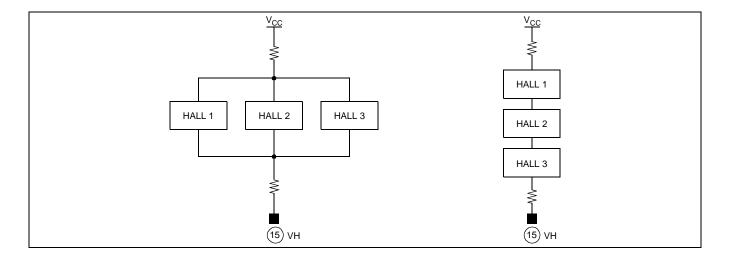
Rotation	H2	H3	D-F/F	Reverse rotat	tion preventer
			(Q)	E _C >E _{CR}	E _C >E _{CR}
Forward	Н	H→L	Н	Forward	_
Reverse	L	H→L	L	_	Brake and stop



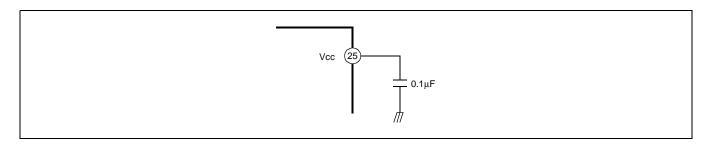
7. FG OUTPUT



8. HALL SENSOR CONNECTION



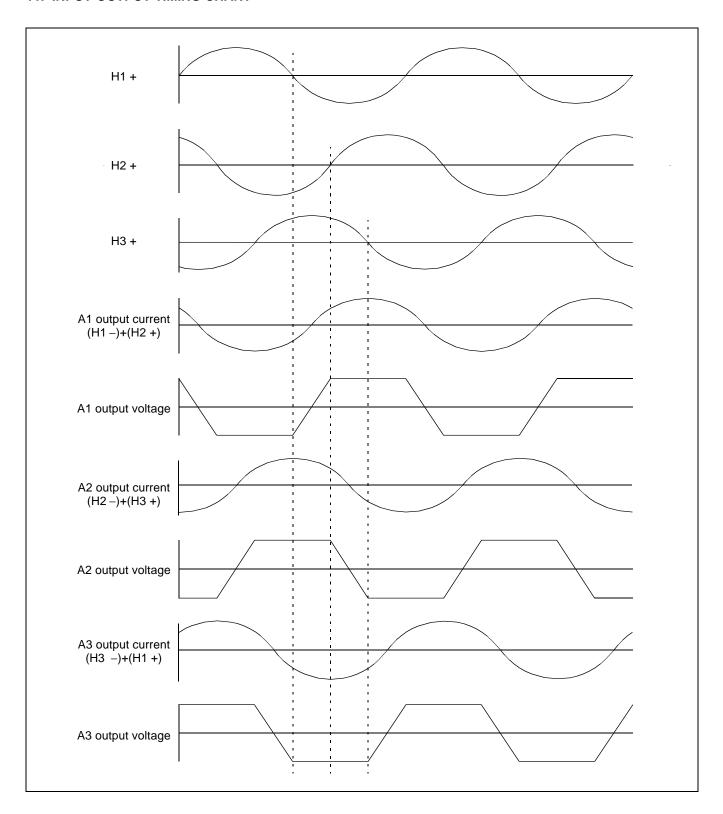
9. Connect a by-pass capacitor, $0.1\mu F$ between the supply voltage source



10. The heat radiation fin is connected to the internal GND of the package. Connect that fin to the external GND.

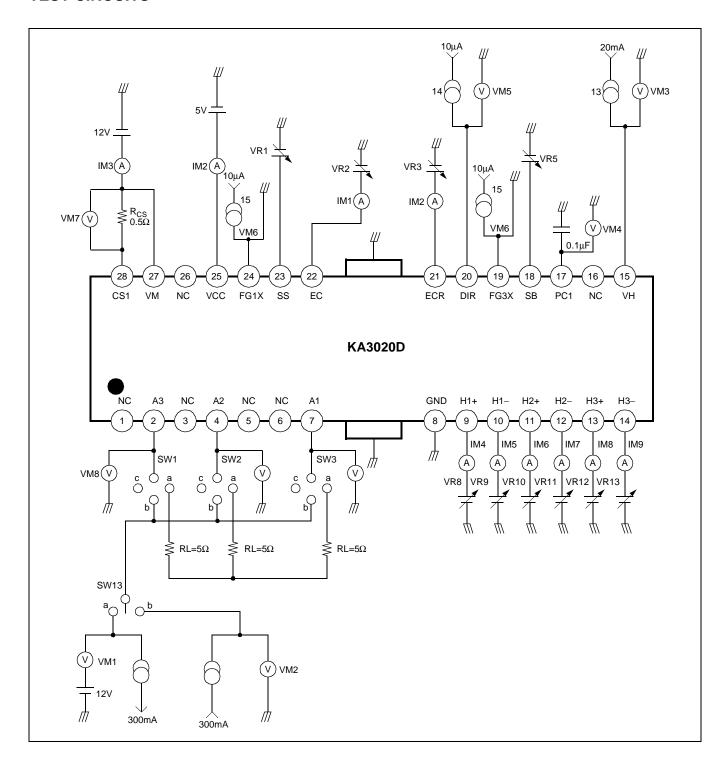


11. INPUT-OUTPUT TIMING CHART

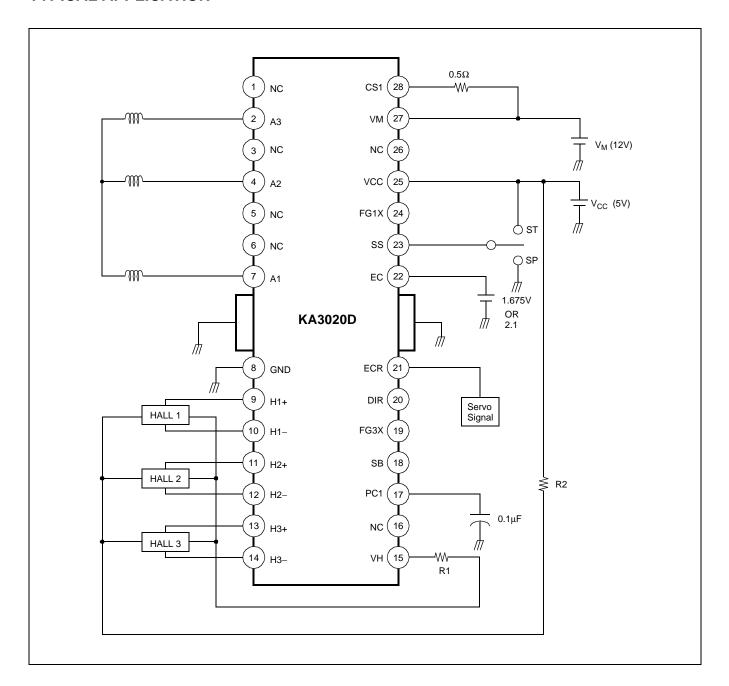




TEST CIRCUITS



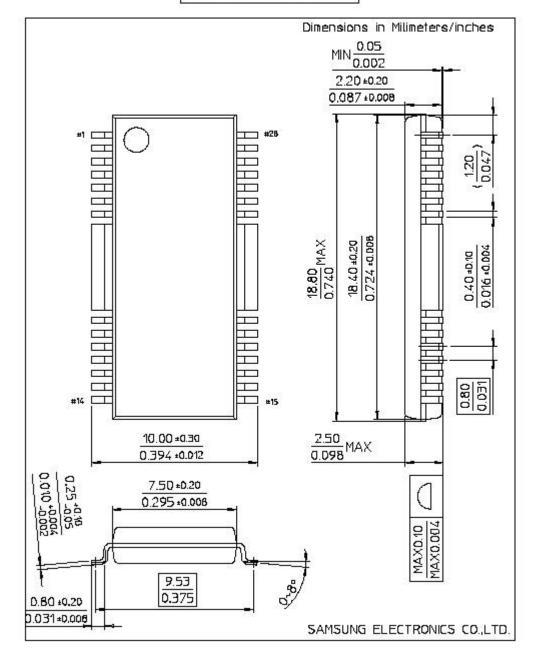
TYPICAL APPLICATION





PACKAGE DIMENSION

28-SSOPH-375





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